The ES1022SI IC provides four delay adjustable sequenced outputs while monitoring an input voltage all with a minimum of external components．

High performance DSP，FPGA，$\mu \mathrm{P}$ and various sub－ systems require input power sequencing for proper functionality at initial power up and the ES1022SI provides this function while monitoring the distributed voltage for over and undervoltage compliance．
This IC operates over the +3.3 V to +24 V nominal voltage range．It has a user adjustable time from UV and OV voltage compliance to sequencing start via an external capacitor when in auto start mode and adjustable time delay to subsequent EN output signal via external resistors．
Additionally，the ES1022SI provides I／O for sequencing on and off operation（SEQ＿EN）and for voltage window compliance reporting（FAULT）over the +3.3 V to +24 V nominal voltage range．
Easily daisy chained for more than 4 sequenced signals．
Altogether，the ES1022SI provides these adjustable features with a minimum of external BOM．See Figure 1 for typical implementation．

## Features

－Adjustable Delay to Subsequent EN Signal
－Adjustable Delay to Sequence Auto Start
－Adjustable Distributed Voltage Monitoring
－Under and Overvoltage Adjustable Delay to Auto Start Sequence
－I／O Options：EN and SEQ＿EN
－Voltage Compliance Fault Output
－Pb－Free Plus Anneal Available（RoHS Compliant）

## Applications

－Power Supply Sequencing
－System Timing Function


FIGURE 1．ES1022SI IMPLEMENTATION
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101 Innovation Drive \begin{tabular}{l}

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## Ordering Information

| PART NUMBER (Note 1) | TEMP. <br> PART MARKING | PACKAGE <br> (Pb-free) | PKG. <br> DWG. \# |  |
| :--- | :--- | :--- | :--- | :--- |
| ES1022SI ${ }^{*}$ | ES1022SI | -40 to +85 | 14 Ld SOIC | M14.15 |
| EVB-ES1022SI | Evaluation Platform |  |  |  |

*Add "-T" suffix for tape and reel. Please refer to Packing and Marking Information: www.altera.com/support/reliability/packing/rel-packing-and-marking.html
NOTES:

1. Altera Enpirion Pb -free plus anneal products employ special Pb -free material sets; molding compounds/die attach materials and $100 \%$ matte tin plate termination finish, which are RoHS compliant and compatible with both Sn Pb and Pb -free soldering operations. Altera Enpirion Pb -free products are MSL classified at Pb -free peak reflow temperatures that meet or exceed the Pb -free requirements of IPC/JEDEC J STD-020.

## Pinout

ES1022SI
(14 LD SOIC)
TOP VIEW

| En_d 7 | 14 VIN |
| :---: | :---: |
| En_C ${ }^{2}$ | 13 TDLY_CD |
| EN_B ${ }^{3}$ | 12 TDLY_BC |
| En_A 4 | 11] TDLY_AB |
| OV 5 | 10 TIME |
| UV 6 | 9 SEQ_EN |
| GND 7 | 8 FAULT |

## Pin Descriptions

| Pin Number | PIN NAME | FUNCTION DESCRIPTION |
| :---: | :---: | :---: |
| 1 | EN_D | EN output D. Active high open drain sequenced output. Sequenced on after EN_C and first output to sequence off. Pulls low with $\mathrm{V}_{\text {IN }}<1 \mathrm{~V}$. |
| 2 | EN_C | EN output C. Active high open drain sequenced output. Sequenced on after EN_B and sequenced off after EN_D. Pulls low with $\mathrm{V}_{\text {IN }}<1 \mathrm{~V}$. |
| 3 | EN_B | EN output B. Active high open drain sequenced output. Sequenced on after EN_A and sequenced off after EN_C. Pulls low with $\mathrm{V}_{\text {IN }}<1 \mathrm{~V}$. |
| 4 | EN_A | EN output A. Active high open drain sequenced output. Sequenced on after CTIME period and sequenced off after EN_B. Pulls low with $\mathrm{V}_{\text {IN }}<1 \mathrm{~V}$. |
| 5 | OV | The voltage on this pin must be under its 1.22 V Vth or the four EN outputs will be immediately pulled down. |
| 6 | UV | The voltage on this pin must be over its 1.22 V Vth or the four EN outputs will be immediately pulled down. |
| 7 | GND | IC ground. |
| 8 | FAULT | The $\mathrm{V}_{1 \mathrm{I}}$ voltage when not within the desired UV to OV window will cause FAULT to be released to be pulled high to a voltage equal to or less than $\mathrm{V}_{\text {IN }}$ via an external resistor. |
| 9 | SEQ_EN | This pin provides a sequence on signal input with a high input. Internally pulled high to $\sim 2.4 \mathrm{~V}$. |
| 10 | TIME | This pin provides a $2.6 \mu \mathrm{~A}$ current output so that an adjustable $\mathrm{V}_{\text {IN }}$ valid to sequencing on and off start delay period is created with a capacitor to ground. |
| 11 | TDLY_AB | A resistor connected from this pin to ground determines the time delay from EN_A being active to EN _B being active on turnon and also going inactive on turn-off via the SEQ_EN input. |
| 12 | TDLY_BC | A resistor connected from this pin to ground determines the time delay from EN_B being active to EN_C being active on turnon and also going inactive on turn-off via the SEQ_EN input. |
| 13 | TDLY_CD | A resistor connected from this pin to ground determines the time delay from EN_C being active to EN _D being active on turnon and also going inactive on turn-off via the SEQ_EN input. |
| 14 | $\mathrm{V}_{\text {IN }}$ | IC Bias Pin Nominally 3.3V to 24 V This pin requires a $1 \mu \mathrm{~F}$ decoupling capacitor close to IC pin. |

## Absolute Maximum Ratings

$\mathrm{V}_{\mathrm{IN}}$, EN, FAULT .
..................................
. 27 V , to -0.3 V
TIME, TDLY_AB, TDLY_BC, TDLY_CD, UV, OV .+6V, to -0.3V
SEQ_EN..................................... . . . VIN +0.3 V , to -0.3 V
EN Output Current
10 mA

## Operating Conditions

Temperature Range $\qquad$ $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Supply Voltage Range (Nominal) 3.3 V to 24 V

## Thermal Information

Thermal Resistance (Typical, Note 2) . . . . . . . . . . . $\theta_{\mathrm{JA}}\left({ }^{\circ} \mathrm{C} / \mathrm{W}\right)$ 14 Ld SOIC . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . . 110
Maximum Junction Temperature (Plastic Package) $\quad+125^{\circ} \mathrm{C}$
Maximum Storage Temperature Range . . . . . . $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ Maximum Lead Temperature (Soldering 10s) . . . . . . . $+300^{\circ} \mathrm{C}$ (SOIC Lead Tips Only)

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:
2. $\theta_{\mathrm{JA}}$ is measured with the component mounted on a high effective thermal conductivity test board in free air.

Electrical Specifications Nominal $\mathrm{V}_{\mathbb{I N}}=3.3 \mathrm{~V}$ to $+24 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, Unless Otherwise Specified.

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| UV AND OV INPUTS |  |  |  |  |  |  |
| UV/OV Rising Threshold | V UVRuth |  | 1.16 | 1.21 | 1.28 | V |
| UV/OV Falling Threshold | $V_{\text {UVFvth }}$ |  | 1.06 | 1.10 | 1.18 | V |
| UV/OV Hysteresis | $\mathrm{V}_{\text {UVhys }}$ | $V_{\text {UVRvth }}-V_{\text {UVFuth }}$ | - | 104 | - | mV |
| UV/OV Input Current | $\mathrm{I}_{\text {UV }}$ |  | - | 10 | - | nA |
| TIME, EN OUTPUTS |  |  |  |  |  |  |
| TIME Pin Charging Current | $\mathrm{I}_{\text {TIME }}$ |  | - | 2.6 | - | $\mu \mathrm{A}$ |
| TIME Pin Threshold | $\mathrm{V}_{\text {TIME_VTH }}$ |  | 1.9 | 2.0 | 2.25 | V |
| Time from V ${ }_{\text {IN }}$ Valid to EN_A | $\mathrm{t}_{\text {VINSEQpd }}$ | SEQ_EN = high, $\mathrm{C}_{\text {TIME }}=$ open | - | 30 | - | $\mu \mathrm{s}$ |
|  | $\mathrm{t}_{\text {VINSEQpd_10 }}$ | SEQ_EN = high, $\mathrm{C}_{\text {TIME }}=10 \mathrm{nF}$ | - | 7.7 | - | ms |
|  | $\mathrm{t}_{\text {VINSEQpd500 }}$ | SEQ_EN $=$ high, $\mathrm{C}_{\text {TIME }}=500 \mathrm{nF}$ | - | 435 | - | ms |
| Time from $\mathrm{V}_{\text {IN }}$ Invalid to Shutdown | $\mathrm{t}_{\text {shutdown }}$ | UV or OV to simultaneous shutdown | - | - | 1 | $\mu \mathrm{S}$ |
| EN Output Resistance | $\mathrm{R}_{\mathrm{EN}}$ | $\mathrm{I}_{\mathrm{EN}}=1 \mathrm{~mA}$ | - | 100 | - | $\Omega$ |
| EN Output Low | Vol | $\mathrm{I}_{\mathrm{EN}}=1 \mathrm{~mA}$ | - | 0.1 | - | V |
| EN Pull-down Current | $\mathrm{I}_{\text {pulld }}$ | $\mathrm{EN}=1 \mathrm{~V}$ | 10 | 15 | - | mA |
| Delay to Subsequent EN Turn-on/off | $\mathrm{t}_{\text {del_120 }}$ | $\mathrm{R}_{\mathrm{TX}}=120 \mathrm{k} \Omega$ | 155 | 195 | 240 | ms |
|  | $\mathrm{t}_{\text {del } \_3}$ | $\mathrm{R}_{\mathrm{TX}}=3 \mathrm{k} \Omega$ | 3.5 | 4.7 | 6 | ms |
|  | $\mathrm{t}_{\text {del_0 }}$ | $\mathrm{R}_{\text {TX }}=0 \Omega$ | - | 0.5 | - | ms |
| SEQUENCE EN AND FAULT I/O |  |  |  |  |  |  |
| $\mathrm{V}_{\text {IN }}$ Valid to FAULT Low | $\mathrm{t}_{\text {FLTL }}$ |  | 15 | 30 | 50 | $\mu \mathrm{S}$ |
| $V_{\text {IN }}$ Invalid to FAULT High | $\mathrm{t}_{\text {FLTH }}$ |  | - | 0.5 | - | $\mu \mathrm{S}$ |
| FAULT Pull-down Current |  | FAULT = 1V | 10 | 15 | - | mA |
| SEQ_EN Pull-up Voltage | $\mathrm{V}_{\text {SEQ }}$ | SEQ_EN open | - | 2.4 | - | V |
| SEQ_EN Low Threshold Voltage | Vil ${ }_{\text {SEQ_EN }}$ |  | - | - | 0.3 | V |
| SEQ_EN High Threshold Voltage | Vih $\mathrm{SEQ}_{\text {_EN }}$ |  | 1.2 | - | - | V |
| Delay to EN_A Deasserted | $\mathrm{t}_{\text {SEQ_EN_ENA }}$ | SEQ_EN low to EN_A low | - | 0.2 | 1 | $\mu \mathrm{S}$ |

Electrical Specifications Nominal $\mathrm{V}_{\mathbb{N}}=3.3 \mathrm{~V}$ to $+24 \mathrm{~V}, \mathrm{~T}_{\mathrm{A}}=\mathrm{T}_{\mathrm{J}}=-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$, Unless Otherwise Specified. (Continued)

| PARAMETER | SYMBOL | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| BIAS |  |  |  |  |  |  |
| IC Supply Current | $I_{\text {VIN_3.3V }}$ | $\mathrm{V}_{\text {IN }}=3.3 \mathrm{~V}$ | - | 191 | - | $\mu \mathrm{A}$ |
|  | IVIN_12V | $\mathrm{V}_{\text {IV }}=12 \mathrm{~V}$ | - | 246 | 400 | $\mu \mathrm{A}$ |
|  | IVIN_24V | $\mathrm{V}_{\text {IV }}=24 \mathrm{~V}$ | - | 286 | - | $\mu \mathrm{A}$ |
| $\mathrm{V}_{\text {IN }}$ Power On Reset | $\mathrm{V}_{\text {IN_POR }}$ | $\mathrm{V}_{\text {IN }}$ low to high | - | 2.3 | 2.8 | V |

## Functional Block Diagram



## Functional Description

ES1022SI provides four delay adjustable sequenced outputs while monitoring a single distributed voltage in the nominal range of 3.3 V to 24 V for both under and overvoltage. Only when the voltage is in compliance will the ES1022SI initiate the pre-programmed A-B-C-D sequence of the EN outputs. Although this IC has a bias range of 3.3 V to 24 V it can monitor any voltage $>1.22 \mathrm{~V}$ via the external divider if a suitable bias voltage is otherwise provided.

During initial bias voltage $\left(\mathrm{V}_{\text {IN }}\right)$ application the ES1022SI EN outputs are held low once $\mathrm{V}_{\text {IN }}=1 \mathrm{~V}$. Once $\mathrm{V}_{\text {IN }}>$ the V bias power on reset threshold (POR) of $2.8 \mathrm{~V}, \mathrm{~V}_{\text {IN }}$ is constantly monitored for compliance via the input voltage resistor divider and the voltages on the UV and OV pins and reported by the FAULT output. Internally, voltage regulators generate 3.5 V and $1.17 \mathrm{~V} \pm 5 \%$ voltage rails for internal usage once $\mathrm{V}_{\text {IN }}>$ POR. Once $\mathrm{UV}>1.22 \mathrm{~V}$ and with the SEQ_EN pin high or open, the auto sequence of the four EN outputs begins as the TIME pin charges its external capacitor with a $2.6 \mu \mathrm{~A}$ current source. The voltage on TIME is compared to the internal reference ( $\mathrm{V}_{\text {TIME_VTH }}$ ) comparator input and when greater than $\mathrm{V}_{\text {TIME_VTH }}$ the EN_A is released to go high via an external pull-up resistor or a pull-up in a DC/DC convertor EN input, for example. The time delay generated by the external capacitor is to assure continued voltage compliance within the programmed limits, as during this time any OV or UV condition will halt the start-up process. TIME cap is discharged once $\mathrm{V}_{\text {TIME_VTH }}$ is met.

Once EN_A is active (released high on the ES1022SI) a counter is started and using the resistor on TDLY_AB as a timing component a delay is generated before EN_B is activated. At this time, the counter is restarted using the resistor on TDLY_BC as its timing component for a separate timed delay until EN_C is activated. This process is repeated for the resistor on TDLY_CD to complete the A-B-C-D sequencing order of the EN outputs. At any time during sequencing if an OV or UV event is registered, all four EN outputs will immediately return to their low reset state. $\mathrm{C}_{\text {TIME }}$ is immediately discharged after initial ramp up thus waiting for subsequent voltage compliance to restart. Once sequencing is complete, any subsequently registered UV or OV event will trigger an immediate and simultaneous reset of all EN outputs.
On the ES1022SI, enabling of on or off sequencing can also be signaled via the SEQ_EN input pin once voltage compliance is met. Initially, the SEQ_EN pin should be held low and released when sequence start is desired. SEQ_EN is internally pulled high and sequencing is enabled unless it is pulled low. The on sequence of the EN outputs is as previously described. The off sequence is D off, then C off, then B off and finally A off. Once SEQ_EN is signaled low, the TIME cap is charged to 2 V once again. Once this Vth is reached, EN_D transitions to its reset state and CTIM is discharged. A delay and subsequent sequence off is then determined by TDLY_CD resistor to EN_C. Likewise, a delay to EN_B and then EN_A turn-off is determined by TDLY_BC and TDLY_AB resistor values respectively.
The FAULT signal is always valid at operational voltages and can be used as justification for SEQ_EN release or even controlled with an RC timer for sequence on.

## Programming the Under and Overvoltage Limits

When choosing resistors for the divider remember to keep the current through the string bounded by power loss at the top end and noise immunity at the bottom end. For most applications, total divider resistance in the $10 \mathrm{k} \Omega$ to $1000 \mathrm{k} \Omega$ range is advisable with high precision resistors being used to reduce monitoring error. Although for the ES1022SI, two dividers of two resistors each can be employed to separately monitor the OV and UV levels for the $\mathrm{V}_{\text {IN }}$ voltage. We will discuss using a single three resistor string for monitoring the $\mathrm{V}_{\mathrm{IN}}$ voltage, referencing Figure 1. In the three resistor divider string with Ru (upper), Rm (middle) and Rl (lower), the ratios of each in combination to the other two is balanced to achieve the desired UV and OV trip levels. Although this IC has a bias range of 3.3 V to 24 V , it can monitor any voltage $>1.22 \mathrm{~V}$.
The ratio of the desired overvoltage trip point to the internal reference is equal to the ratio of the two upper resistors to the lowest (gnd connected) resistor.
The ratio of the desired undervoltage trip point to the internal reference voltage is equal to the ratio of the uppermost (voltage connected) resistor to the lower two resistors.
These assumptions are true for both rising (turn-on) or falling (shutdown) voltages.
The following is a practical example worked out. For detailed equations on how to perform this operation for a given supply requirement please see the next section.

1. Determine if turn-on or shutdown limits are preferred. In this example, we will determine the resistor values based on the shutdown limits.
2. Establish lower and upper trip level: $12 \mathrm{~V} \pm 10 \%$ or $13.2 \mathrm{~V}(\mathrm{OV})$ and 10.8 V (UV)
3. Establish total resistor string value: $100 \mathrm{k} \Omega \mathrm{Ir}=$ divider current
4. $(\mathrm{Rm}+\mathrm{Rl}) \times \mathrm{Ir}=1.1 \mathrm{~V} @ \mathrm{UV}$ and $\mathrm{Rl} \times \mathrm{Ir}=1.2 \mathrm{~V} @ \mathrm{OV}$
5. $\mathrm{Rm}+\mathrm{Rl}=1.1 \mathrm{~V} / \mathrm{Ir} @ \mathrm{UV}=\mathrm{Rm}+\mathrm{Rl}=1.1 \mathrm{~V} /(10.8 \mathrm{~V} / 100 \mathrm{k} \Omega)=10.370 \mathrm{k} \Omega$
6. $\mathrm{Rl}=1.2 \mathrm{~V} / \mathrm{Ir} @ \mathrm{OV}=\mathrm{Rl}=1.2 \mathrm{~V} /(13.2 \mathrm{~V} / 100 \mathrm{k} \Omega)=9.242 \mathrm{k} \Omega$
7. $\mathrm{Rm}=10.370 \mathrm{k} \Omega-9.242 \mathrm{k} \Omega=1.128 \mathrm{k} \Omega$
8. $\mathrm{Ru}=100 \mathrm{k} \Omega-10.370 \mathrm{k} \Omega=89.630 \mathrm{k} \Omega$
9. Choose standard value resistors that most closely approximate these ideal values. Choosing a different total divider resistance value may yield a more ideal ratio with available resistor's values.
In our example, with the closest standard values of $\mathrm{Ru}=90.9 \mathrm{k} \Omega, \mathrm{Rm}=1.13 \mathrm{k} \Omega$ and $\mathrm{Rl}=9.31 \mathrm{k} \Omega$, the nominal UV falling and OV rising will be at 10.9 V and 13.3 V respectively.

## Programming the EN Output Delays

The delay timing between the four sequenced EN outputs are programmed with four external passive components. The delay from SEQ_EN being valid to EN_A is determined by the value of the capacitor on the TIME pin to GND. The external TIME pin capacitor is charged with a $2.6 \mu \mathrm{~A}$ current source. Once the voltage on TIME is charged up to the internal
reference voltage, $\left(\mathrm{V}_{\text {TIME_VTH }}\right)$ the EN_A output is released out of its reset state. The capacitor value for a desired delay ( $\pm 10 \%$ ) to EN_A once $\mathrm{V}_{\text {IN }}$ and SEQ_EN where applicable has been satisfied is determined by:
$\mathrm{C}_{\text {TIME }}=\mathrm{t}_{\text {VINSEQpd }} / 770 \mathrm{k} \Omega$
Once EN_A reaches $\mathrm{V}_{\text {TIME_VTh, }}$, the TIME pin is pulled low in preparation for a sequenced off signal via SEQ_EN. At this time, the sequencing of the subsequent outputs is started. EN_B is released out of reset after a programmable time, then EN_C, then EN_D, all with their own programmed delay times.

The subsequent delay times are programmed with a single external resistor for each EN output providing maximum flexibility to the designer through the choice of the resistor value connected from TDLY_AB, TDLY_BC and TDLY_CD pins to GND. The resistor values determine the charge and discharge rate of an internal capacitor comprising an RC time constant for an oscillator whose output is fed into a counter generating the timing delay to EN output sequencing.

The $R_{T X}$ value for a given delay time is defined as:
$\mathrm{R}_{\mathrm{TX}}=\mathrm{t}_{\text {del }} / 1667 \mathrm{nF}$

## An Advanced Tutorial on Setting UV and OV Levels

This section discusses in additional detail the nuances of setting the UV and OV levels, providing more insight into the ES1022SI than the earlier text.

The following equation set can alternatively be used to work out ideal values for a 3 resistor divider string of $\mathrm{Ru}, \mathrm{Rm}$ and Rl . These equations assume that $V_{\text {REF }}$ is the center point between $V_{\text {UVRvth }}$ and $V_{\text {UVFvth }}$ (i.e. $\left(V_{\text {UVRvth }}+V_{\text {UVFvth }}\right) / 2=1.17 \mathrm{~V}$ ), Iload is the load current in the resistor string (i.e. $\mathrm{V}_{\text {IN }} /(\mathrm{Ru}+\mathrm{Rm}+\mathrm{Rl})$ ), $\mathrm{V}_{\text {IN }}$ is the nominal input voltage and Vtol is the acceptable voltage tolerance, such that the UV and OV thresholds are centered at $\mathrm{V}_{\mathrm{IN}} \pm \mathrm{V}$ tol. The actual acceptable voltage window will also be affected by the hysteresis at the UV and OV pins. This hysteresis is amplified by the resistor string such that the hysteresis at the top of the string is:
Vhys $=V_{\text {UVhys }} \times V_{\text {OUT }} / V_{\text {REF }}$
This means that the $\mathrm{V}_{\text {IN }} \pm$ Vtol thresholds will exhibit hysteresis resulting in thresholds of $\mathrm{V}_{\text {IN }}+\mathrm{V}$ tol $\pm \mathrm{Vhys} / 2$ and $\mathrm{V}_{\text {IN }}$ - Vtol $\pm$ Vhys/2.

There is a window between the $V_{\text {IN }}$ rising UV threshold and the $V_{\text {IN }}$ falling $O V$ threshold where the input level is guaranteed not to be detected as a fault. This window exists between the limits $\mathrm{V}_{\text {IN }} \pm$ (Vtol - Vhys/2). There is an extension of this window in each direction up to $\mathrm{V}_{\text {IN }} \pm$ (Vtol + Vhys/2), where the voltage may or may not be detected as a fault, depending on the direction from which it is approached. These two equations may be used to determine the required value of V tol for a given system. For example, if $\mathrm{V}_{\text {IN }}$ is 12 V , $\mathrm{Vhys}=(0.1 \times 12) / 1.17=1.03 \mathrm{~V}$. If $\mathrm{V}_{\text {IN }}$ must remain within $12 \mathrm{~V} \pm 1.5 \mathrm{~V}, \mathrm{Vtol}=1.5-1.03 / 2=0.99 \mathrm{~V}$. This will give a window of $12 \pm 0.48 \mathrm{~V}$ where the system is guaranteed not to be in fault and a limit of $12 \pm 1.5 \mathrm{~V}$ beyond which the system is guaranteed to be in fault.
It is wise to check both these voltages, for if the latter is made to tight, the former will cease to exist. This point comes when Vtol < Vhys/ 2 and results from the fact that the acceptable window for the OV pin no longer aligns with the acceptable window for the UV pin. In this case, the application will have to be changed such that UV and OV are provided separate resistor strings. In this case, the UV and OV thresholds can be individually controlled by adjusting the relevant divider.

The previous example will give voltage thresholds of:

```
with \(V_{\text {IN }}\) rising
\(\mathrm{UVr}=\mathrm{V}_{\text {IN }}-\mathrm{Vtol}+\mathrm{Vhys} / 2=11.5 \mathrm{~V}\) and
\(\mathrm{OVr}=\mathrm{V}_{\text {IN }}+\mathrm{Vtol}+\mathrm{Vhys} / 2=13.5 \mathrm{~V}\)
with \(V_{\text {IN }}\) falling
Ovf \(=\mathrm{V}_{\text {IN }}+\) Vtol - Vhys \(/ 2=12.5 \mathrm{~V}\) and
\(\mathrm{UVf}=\mathrm{V}_{\text {IN }}-\) Vtol - Vhys \(/ 2=10.5 \mathrm{~V}\).
```

So with a single three resistor string, the resistor values can be calculated as:

```
\(\mathrm{Rl}=\left(\mathrm{V}_{\mathrm{REF}} /\right.\) Iload \()\left(1-\mathrm{Vtol} / \mathrm{V}_{\mathrm{IN}}\right)\)
\(\mathrm{Rm}=2\left(\mathrm{~V}_{\text {REF }} \times \mathrm{Vtol}\right) /\left(\mathrm{V}_{\text {IN }} \times\right.\) Iload \()\)
\(\mathrm{Ru}=1 / \operatorname{Iload} \times\left(\mathrm{V}_{\text {IN }}-\mathrm{V}_{\text {REF }}\left(1+\mathrm{Vtol} / \mathrm{V}_{\text {IN }}\right)\right)\)
```

Page 8

For the above example, with V tol $=0.99 \mathrm{~V}$, assuming a $100 \mu \mathrm{~A}$ Iload at $\mathrm{V}_{\text {IN }}=12 \mathrm{~V}$ :
$\mathrm{Rl}=10.7 \mathrm{k} \Omega$
$\mathrm{Rm}=1.9 \mathrm{k} \Omega$
$\mathrm{Ru}=107.3 \mathrm{k} \Omega$


FIGURE 2. ES1022SI OPERATIONAL DIAGRAM


FIGURE 3. ES1022SI FAULT OPERATIONAL DIAGRAM

## Typical Performance Curves



FIGURE 4. UV/OV RISING THRESHOLD


FIGURE 5. $\mathrm{V}_{\text {IN }}$ CURRENT

## Applications Usage

## Using the EVB-ES1022SI Platform

The EVB-ES1022SI platform is the primary evaluation board for this family of sequencers. See Figure 15 for photograph and schematic. The evaluation board is shipped with an ES1022SI mounted in the left position and with the other device variants loose packed. In the following discussion, test points names are bold on initial occurrence for identification.

The $\mathbf{V}_{\text {IN }}$ test point is the chip bias and can be biased from 3.3 V to 24 V . The VHI test point is for the EN and FAULT pull-up voltage which are limited to a maximum of 24 V independent of $\mathrm{V}_{\mathrm{IN}}$. The UV/OV resistor divider is set so that a nominal 12 V on the VMONITOR test point is compliant and with a rising OV set at 13.2 V and a falling UV set at 10.7 V . These three test points ( $\mathrm{V}_{\mathrm{IN}}, \mathrm{VHI}$ and VMONITOR ) are brought out separately for maximum flexibility in evaluation.

VMONITOR ramping up and down through the UV and OV levels will result in the FAULT output signaling the out of bound conditions by being released to pull high to the VHI voltage as shown in Figures 6 and 7.

Once the voltage monitoring FAULT is resolved and where applicable, the SEQ_EN is satisfied, sequencing of the EN_X outputs begins. When sequence enabled the EN_A, EN_B, EN_C and lastly EN_D are asserted in that order and when SEQ_EN is disabled the order is reversed. See Figures 8 and 9 demonstrating the sequenced enabling and disabling of the EN outputs. The timing between EN outputs is set by the resistor values on the TDLY_AB, TDLY_BC, TDLY_CD pins as shown. Figure 10 illustrates the timing from either SEQ_EN and/or VMONITOR being valid to EN_A being asserted with a 10nF TIME capacitor. Figure 11 shows that EN_X outputs are pulled low even before $\mathrm{V}_{\text {IN }}$ $=1 \mathrm{~V}$. This is critical to ensure that a false EN is not signaled. Figure 12 shows the time from SEQ_EN transition with the voltage ramping across the TIME capacitor to TIME Vth being met. This results in the immediate pull down of the TIME pin and simultaneous EN_A enabling.


FIGURE 6. VMONITOR RISING TO FAULT


FIGURE 7. VMONITOR FALLING TO FAULT




FIGURE 12. SEQ_EN TO EN_A



FIGURE 11. EN AS VIN RISES


FIGURE 13. OV AND UV TRANSIENT IMMUNITY

## Application Recommendations

Best practices $\mathrm{V}_{\text {IN }}$ decoupling is required, a $1 \mu \mathrm{~F}$ capacitor is recommended.
Coupling from the EN_X pins to the sensitive UV and OV pins can cause false OV/UV events to be detected. This is relevant due to the EN_A and OV pins being adjacent. This coupling can be reduced by adding a ground trace between UV and the EN/FAULT signals, as shown in Figure 14. The PCB traces on OV and UV should be kept as small as practical and the EN_X and FAULT traces should ideally not be routed under/over the OV/UV traces on different PCB layers unless there is a ground or power plane in between. Other methods that can be used to eliminate this issue are by reducing the value of the resistors in the network connected to UV and OV (R2, R3, R5 in Figure 15) or by adding small decoupling capacitors to OV and UV (C2 and C7 in Figure 15). Both these methods act to reduce the AC impedance at the nodes, although the latter method acts to filter the signals which will also cause an increase in the time that a UV/OV fault takes to be detected.

When the ES1022SI is implemented on a hot swappable card that is plugged into an always powered passive back plane an $R C$ filter is required on the $\mathrm{V}_{\text {IN }}$ pin to prevent a high dv/dt transient. With the already existing $1 \mu \mathrm{~F}$ decoupling capacitor the addition of a small series $R(>50 \Omega)$ to provide a time constant $>50 \mu$ s is all that is necessary.


FIGURE 14. LAYOUT DETAIL OF GND BETWEEN PINS 4 AND 5


FIGURE 15. EVB-ES1022SI PHOTOGRAPH AND SCHEMATIC OF LEFT CHANNEL
TABLE 1. EVB-ES1022SI LEFT CHANNEL COMPONENT LISTING

| COMPONENT DESIGNATOR | COMPONENT FUNCTION | COMPONENT DESCRIPTION |
| :---: | :---: | :---: |
| U1 | ES1022SI, Quad Under/Overvoltage Sequencer | Altera Enpirion, ES1022SI, Quad Under/Overvoltage Sequencer |
| R3 | UV Resistor for Divider String | $1.1 \mathrm{k} \Omega 1 \%, 0603$ |
| R2 | VMONITOR Resistor for Divider String | 88.7k 1 \%, 0603 |
| R5 | OV Resistor for Divider String | $9.1 \mathrm{k} \Omega 1 \%, 0603$ |
| C1 | $\mathrm{C}_{\text {TIME }}$ Sets Delay from Sequence Start to First EN | 0.01 $\mu \mathrm{F}, 0603$ |
| R1 | R ${ }_{\text {TDLY_CD }}$ Sets Delay from Third to Fourth EN | 120kS $1 \%$, 0603 |
| R9 | $\mathrm{R}_{\text {TDLY_AB }}$ Sets Delay from First to Second EN | $3.01 \mathrm{k} \Omega 1 \%, 0603$ |
| R7 | $\mathrm{R}_{\text {TDLY_BC }}$ Sets Delay from Second to Third EN | 51k $1 \%$, 0603 |
| R4, R6, R8, R10, R11 | EN_X and FAULT Pull-up Resistors | 4k $310 \%, 0402$ |
| C3 | Decoupling Capacitor | 1 $\mu$ F, 0603 |

## Revision History

The table lists the revision history for this document.

| DATE | REVISION | CHANGE |
| :---: | :---: | :--- |
| May, 2014 | 1.0 | Initial Release. |

Small Outline Plastic Packages (SOIC)


NOTES:

1. Symbols are defined in the "MO Series Symbol List" in Section 2.2 of Publication Number 95.
2. Dimensioning and tolerancing per ANSI Y14.5M-1982.
3. Dimension "D" does not include mold flash, protrusions or gate burrs. Mold flash, protrusion and gate burrs shall not exceed 0.15 mm ( 0.006 inch) per side.
4. Dimension " $E$ " does not include interlead flash or protrusions. Interlead flash and protrusions shall not exceed 0.25 mm ( 0.010 inch) per side.
5. The chamfer on the body is optional. If it is not present, a visual index feature must be located within the crosshatched area.
6. "L" is the length of terminal for soldering to a substrate.
7. " N " is the number of terminal positions.
8. Terminal numbers are shown for reference only.
9. The lead width " $B$ ", as measured 0.36 mm ( 0.014 inch ) or greater above the seating plane, shall not exceed a maximum value of 0.61 mm ( 0.024 inch).
10. Controlling dimension: MILLIMETER. Converted inch dimensions are not necessarily exact.

M14.15 (JEDEC MS-012-AB ISSUE C) 14 LEAD NARROW BODY SMALL OUTLINE PLASTIC PACKAGE

| SYMBOL | INCHES |  | MILLIMETERS |  | NOTES |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | MIN | MAX | MIN | MAX |  |
| A | 0.0532 | 0.0688 | 1.35 | 1.75 | - |
| A1 | 0.0040 | 0.0098 | 0.10 | 0.25 | - |
| B | 0.013 | 0.020 | 0.33 | 0.51 | 9 |
| C | 0.0075 | 0.0098 | 0.19 | 0.25 | - |
| D | 0.3367 | 0.3444 | 8.55 | 8.75 | 3 |
| E | 0.1497 | 0.1574 | 3.80 | 4.00 | 4 |
| e | 0.050 BSC |  | 1.27 BSC |  | - |
| H | 0.2284 | 0.2440 | 5.80 | 6.20 | - |
| h | 0.0099 | 0.0196 | 0.25 | 0.50 | 5 |
| L | 0.016 | 0.050 | 0.40 | 1.27 | 6 |
| N | 14 |  | 14 |  | 7 |
| a | $0^{\circ}$ | $8^{0}$ | $0^{\circ}$ | $8^{0}$ | - |

